

FC-3G-ETH-D422-SFP FC-3G-ETH-D422-CWDM-SFP

Flashlink Compact optical transport solution for video, Ethernet, data and GPI

User manual

Rev. E



Nevion Support

Nevion AS

Nevion USA

Lysaker Torg 5 1366 Lysaker, Norway Support phone 1: +47 33 48 99 97 Support phone 2: +47 90 60 99 99 400 West Ventura Boulevard, Suite 155, Camarillo, CA 93010, USA Toll free North America: (866) 515-0811 Outside North America: +1 (805) 247-8560

E-mail: support@nevion.com

See http://www.nevion.com/support/ for service hours for customer support globally.

Revision history

Current revision of this document is the uppermost in the table below.

Rev.	Repl.	Date	Sign	Change description
	-			-
E	D	2019-01-15	MR	Front page: Corrected name for product with CWDM filter.
D	С	2018-12-11	MR	2.1 General: Corrected input voltage range.
С	В	2018-11-30	MR	2.12 Front view: Updated description for status LEDs 2.13: Corrected text in fig. 4 conc. order of SDI ports. 4.3.2: Changed header and added info concerning backshells for 25p Dsub connectors.
В	Α	2018-10-30	MR	2.12 Front view: Added function description for status LEDs
Α	Proto2	2018-09-26	SHH	First production model.
Proto2	Proto1	2018-09-12	MR	In chapter 3. Configuration: Changed function descriptions for DIP switches. Changes apply to fw versions 0.3 and later.
Proto1	Proto	2018-09-07	MR	In chapter 3. Configuration: Corrected function descriptions for DIP switches #6 and 7.
Proto	-	2018-05-04	MR	Initial version. Based partly on manuals; "3GHD-EO-2-SFP.revD", "3GHD-OE-2-SFP.revD", "ETH1000-SFP revB", "D422-MG RevH" and "FlashlinkCompactII.revC"

Contents

Revision history	2
1 Product overview 1.1 General 1.2 Optical video converter functionality	4 4
1.3 Optical GbE transceiver functionality 1.4 RS422 and GPI functionality	
2 Specifications	6 6
2.3 Optical SDI inputs 2.4 Optical SDI outputs 2.5 Electrical SDI input	6 7
2.6 Electrical SDI outputs	7
2.9 GPO	8 8
2.11 GbE	9
3 Configuration	11
4 Connections	.12 .12 .12
4.3.1 General	13 14 14
5 Nevion SFPs	15
6 Laser safety precautions	16
General environmental requirements for Nevion equipment	
Product Warranty	
Appendix A Materials declaration and recycling information	

1 Product overview

1.1 General

Nevion's newest addition to the Flashlink Compact series provides a compact and cost efficient answer to remote production over dark fiber.

The high density chassis is designed to transport multiple video, MADI, IP based audio and intercom systems, control data and tally over a single fiber.

Its small form factor, low power and light weight makes it ideal for smaller stage boxes that can be placed close to where they are needed. And its low noise makes it perfect for forwarding baseband signals to remote production areas where other equipment such as IP switches or gateways can be too noisy.

With Nevions long haul optical interfaces and low loss optical filters distances above 80 km can be achieved making the product ideal for optical metro networks.

And combined with the optical couplers, optical switches and electrical change-overs in the modular Flashlink range improved redundancy mechanisms can be added to the system.

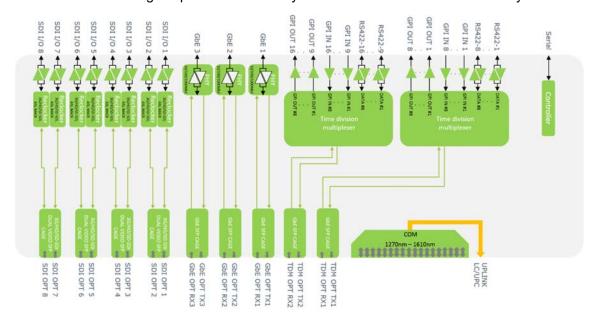


Figure 1 Signal flow

1.2 Optical video converter functionality

An FC-3G-ETH-D422-SFO unit holds four dual channel direction configurable and multi bit-rate optical converter modules providing high performance media conversion for various signal formats from 1Mbps (depending on SFP) up to 2970Mbps. Each module can transport all SD, HD and 3G signal formats in addition to DVB-ASI and SMPTE310M. They perform optical refreshing and signal re-clocking, which is selectable on application. The optical ports are embedded in video specific non-MSA SFP modules and Nevion's dual transmitters, dual receivers and transceivers can be utilized. The open system platform of Nevion Flashlink system allows easy interoperability with third party fiber optical systems. Each electrical video port can be selected as input or output thru the Multicon web interface.

1.3 Optical GbE transceiver functionality

An FC-3G-ETH-D422-SFP includes three 1000Base-T to 1000Base-X media converter modules. These optical modules are based on SFP that makes the optical part exchangeable in field. The module converts a 1000Mbps Ethernet signal on copper to 1000Mbps optical on fibre suitable for medium haul applications. The module has one electrical Ethernet port and one optical fibre transceiver port (receiver fibre connector and transmit fibre connector). Each fibre link occupy two wavelengths in a CWDM installation.

The solution also supports 100MbE, but the transmitted signal still runs at 1000Mbps. It is important that both ends of the link is configured to support the same bit rates as autonegotiation is not transported across the link.

1.4 RS422 and GPI functionality

FC-3G-ETH-D422-SFP includes two D422-MG modules transmitting RS-422 and GPI data signals via fiber optic cable. The D422-MG module multiplexes up to 8 RS-422 and 16 GPI inputs into an outgoing optical datastream while at the same time demultiplexing an incoming optical datastream into 8 RS-422 and 16 GPI outputs.

The optical interface is SFP based and each D422-MG module occupies two wavelength in an CWDM interface.

The D422-MG modules of FC-3G-ETH-D422-SFP/TX units are interoperable with the standalone Flashlink card D-422-MG.

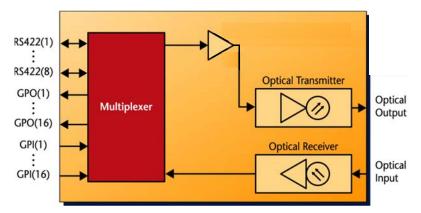


Figure 2 D-422-MG module

2 Specifications

2.1 General

Power +12V to 16V DC /

20W, max (standard SFPs).

Size of chassis 1.7" x 19" x 5.14" (H x W x D)

43.4mm x 482.6mm x 130.5mm (H x W x D)

Depth included connectors: 158,5mm

Weight Approximately 2.06kg / 4.54lb (International pounds)

including SFPs and internal CWDM filter, but not

including external optical patch cables

Control Status LED in front

Configurations DIP in back

Operating temperature 0 to +45 °C

Forced ventilation Four monitored fans, two on each side.

Left to right airflow.

Data rate reclocked: 125, 270, 1485, 1485/1.001, 2970, 2970/1.001 Mbps

Data rate non-reclocked: 1 to 2970 Mbps (Depending on SFP used)

2.2 Supported standards

 SD, 270Mbps
 SMPTE259M

 HD, 1485Mbps
 SMPTE292-2008

 3G, 2999Mbps
 SMPTE424M

 DVB-ASI
 EN50083-9.

Fiber Transmission SMPTE297-2006

AES-10/MADI

AES-3id (non-reclocked)

Electrical connector, BNC IEC 61169-8

2.3 Optical SDI inputs

See Nevion SFP datasheets for specification.

2.4 Optical SDI outputs

See Nevion SFP datasheets for specification.

2.5 Electrical SDI input

Connectors BNC, IEC 61169-8

Impedance 75ohm

Cable equalization Automatic;

300m @270Mbps w/Belden 8281 150m @1485Mbps w/Belden 1694A 90m @ 2970Mbps w/Belden 1694A

Input Return loss <-15dB, 5MHz-1.5GHz

<-10dB, 1.5-3.0GHz

2.6 Electrical SDI outputs

Connectors BNC, IEC 61169-8

Impedance 75ohm

Output signal level 800mV +/- 10%
Output signal rise / fall time 20% - 80%

SD, 0.4ns – 1.5ns, <0.5ns rise/fall variation
 HD/3GHD, < 135ps, <50ps rise/fall variation

DC-offset 0V +/-0,5 Amplitude overshoot <10%

Output return loss <-15dB, 5MHz-1.5GHz

<-10dB, 1.5-3.0GHz

2.7 18 channel CWDM filter (FC-3G-ETH-D422-CWDM-SFP only)

Number of channels 18

Available wavelengths (nm) 1271, 1291, 1311, 1331, 1351, 1371, 1391, 1411, 1431,

1451, 1471, 1491, 1511, 1531, 1551, 1571, 1591, 1611

Connector LC/UPC
Insertion loss (end to end, including connectors)

Channel Spacing
Passband

LC/UPC

5dB typical
6dB max

20nm

13nm min

Transmission circuit fiber 9/125um single mode

Adjacent Channel Isolation 30dB min
Non-Adjacent Channel Isolation 40dB min
Directivity 45dB min
Connector Return loss 45dB min
Polarization depending loss 0.2dB max
Ripple in passband 0.5dB max
Optical Power 17mW max

2.8 **GPI**

Connectors Dsub female, 2 x 25p

"Low" input level 0 to 2.0 VDC

"High" input level 3 to 5.0 VDC or open (Internal pull-ups to 3.3VDC)

Threshold 2.5 VDC

2.9 **GPO**

Connectors Dsub female, 2 x 25p

Output type Open drain (N channel MOSFET)

Max. applied voltage 30VDC Max. applied current 100mA

"Low" output impedance Max. 0.2 ohms to GND

"High" output leakage current max. 10uA at 30VDC applied voltage

2.10 RS-422

Connectors RJ-45 Signal format RS-422

Bit rate DC up to 115.2 kbps

2.11 GbE

Connectors RJ-45 (GbE versions)
Signal format Only GbE supported

2.12 Front view

Use applicable text or drawing.



Figure 3 Front view

Status A indicator:

Gives status on power supply connected to the Power A connector on the back side.

- Green: Power supply connected
- Orange: No or none working power supply connected
- Red: The lower converter is malfunctioning. Please contact Nevion support for advice.
- Blinking LED
 - o When green: 1s green 1s red
 - o When orange or red:1s on-1s off

Fan speed outside limits at the right side fan module, module must be replaced.

Status B indicator:

Gives status on power supply connected to the Power B connector on the back side.

- Green: Power supply connected
- Orange: No or none working power supply connected
- Red: The lower converter is malfunctioning. Please contact Nevion support for advice.
- Blinking LED
 - o When green: 1s green 1s red
 - When orange or red:1s on-1s off

Fan speed outside limits at the left side fan module, module must be replaced.

1 to 18 indicators:

Give status per SFP converter channel.

- Green: Valid input signal and reclocker in lock or bypass.
- Orange: Signal on input, but reclocker not in lock.
- Red: No valid input signal.
- No light: No valid Nevion SFP present.

SFP: Cage for fitting Nevion SFPs.

2.13 Rear view

Use applicable text or drawing.



Figure 4 Rear view

Earth point: For connection to internal earth bar in 19" racks

GPI / GPO: 25p Dsubs, female

RS-422: RJ45 (8pcs): GbE: RS-422 (3pcs)

SDI: BNCs

DIP 1 to 8: Configures the Flashlink Compact II. See chapter 3 for more information.

FLP: RJ45 for programming purpose

Power A: Main DC input connector. Standard 9pin DSUB, male.

Power B: Spare/redundancy DC input connector. Standard 9pin DSUB, male.

3 Configuration

Configuration by 8 pos. DIP switch at rear side:

DIP switch number	Function	On position	Off position
1	"OVR".	DIP settings override	Configurations from
	(Multicon override)	Multicon settings	Multicon
2-3	Subrack ID for Multicon	See table below	See table below
4	GbE-1 link speed	100Mbps	1000Mbps
5	GbE-2 link speed	100Mbps	1000Mbps
6	GbE-3 link speed	100Mbps	1000Mbps
7 and 8	Configuration of SFP directions	See table below	See table below

Configuration of subrack ID for Multicon with DIP switch #2 and 3:

#2 and 3 both in "Off" position:	Frame # in Multicon: 1
#2 in "Off" position, #3 in "On" position:	Frame # in Multicon: 2
#2 in "On" position, #3 in "Off" position:	Frame # in Multicon: 3
#2 and 3 both in "On" position:	Frame # in Multicon: 4

Configuration of directions with DIP switch # 7 and 8:

#7 and 8 both in "Off" position:	Tells the unit that receiver SFPs are mounted in cages # 1 to 4 (marked "1" to "8").
	All SDI ports are configured to be outputs.
#7 and 8 both in "On" position:	Tells the unit that transceiver SFPs are mounted in cages # 1 to 4 (marked "1" to "8").
	SDI ports are configured as follows;
	SDI-1, 3, 5 and 7: Inputs
	SDI-2, 4, 6, and 8: Outputs
#7 in "Off" position, #8 in "On" position:	Tells the unit that receiver SFPs are mounted in cages #1 and 2 (marked "1" to "4") and transmitter SFPs are mounted in cages #3 and 4 (marked "5" to "8").
	SDI ports #1-4 are configured to be outputs
	SDI ports #5-8 are configured to be inputs
#7 in "On" position, #8 in "Off" position:	Tells the unit that transmitter SFPs are mounted in cages # 1 to 4 (marked "1" to "8").
	All SDI ports are configured to be inputs.

4 Connections

4.1 Optical video converter functionality

There are eight separate reclocked SDI channels, each group of two being equivalent to one optical video receiver module.

Remark: Be aware of the unusual order of SDI ports; 2-1-4-3-6-5-8-7.

Connections between BNCs and SFPs are as follows:

BNC marked "SDI-1": SFP cage marked "1 2", part 1 BNC marked "SDI-2": SFP cage marked "1 2", part 2 BNC marked "SDI-3": SFP cage marked "3 4", part 3 BNC marked "SDI-4": SFP cage marked "3 4", part 4 BNC marked "SDI-5": SFP cage marked "5 6", part 5 BNC marked "SDI-6": SFP cage marked "5 6", part 6 BNC marked "SDI-7": SFP cage marked "7 8", part 7 BNC marked "SDI-8": SFP cage marked "7 8", part 8

4.2 Otical GbE transceiver functionality

There are three separate GbE channels each being equivalent to one ETH1000-SFP product.

Connections to SFPs are as follows:

Single connector (Marked "GbE-1"): SFP cage marked "9 10" (5th from

left)

Upper part of dual connector (Marked "GbE-2"): SFP cage marked "11 12" (6th from

left)

Lower part of dual connector (Marked "GbE-3"): SFP cage marked "13 14" (7th from

left)

4.3 D422-MG functionality

4.3.1 General

Connectors are grouped into two sections, each being equivalent to one D-422-MG product.

Group 1:

Upper GPI connector (marked "GPI-1"), upper GPO connector (marked "GPO-1") and the four RJ-45 connectors most remote to the GPI/GPO connectors (marked "RS-422-1 to 4").

This group is internally connected to the SFP cage marked "15 16" (#8 from left)

Group 2:

Lower GPI connector (marked "GPI-2"), lower GPO connector (marked "GPO-2") and the four RJ-45 connectors closest to the GPI/GPO connectors (marked "RS-422-5 to 8").

This group is internally connected to the SFP cage marked "17 18" (#9 from left)

4.3.2 GPI/GPO connectors, pinning and backshell

Input/Output	Pin		
1	12		
2	24		
3	23		
4	10		
5	9		
6	21		
7	20		
8	7		
9	6		
10	18		
11	17		
12	4		
13	3		
14	15		
15	14		
16	1		

Table 1. GPI/GPO connectors pinning

Ground is available on all remaining pins:

2, 5, 8, 11, 13, 16, 19, 22, 25

and also on the connector chassis.

To make it possible to mount two cable connectors side by side, the width of the connector backshell <u>must not exceed 53.3 mm.</u>

Among the significant available selection of housings, here are some possible candidates;

	<u>Manufacturer</u>	Manufacturer Part Number	
Unshielded:	Multicomp	MC-DTPPK25	
	Amphenol	17E-1726-1	
	TE Connectivity	5748678-3	
	Amphenol FCI	8655PHRA2501LF	
	Amphenol FCI	86303639BLF	
Shielded:	TE Connectivity	1-1478762-5	
	TE Connectivity	5748676-3	
	Assmann WSW Components	AGP 25 G-METALL	
	3M	3357-9225	
	TE Connectivity	2-2198617-5	

4.3.3 RS-422 connectors, pinning

RS-422 pin layout:

NO 422 pili layout.						
Signal	Name	Port1	Port2	Mode		
RX +	Receive Pos.	Pin 3	Pin 1	Input		
RX -	Receive Neg.	Pin 6	Pin 2	Input		
TX +	Transmit Pos.	Pin 5	Pin 7	Output		
TX -	Transmit Neg.	Pin 4	Pin 8	Output		

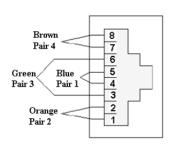


Figure 5 RS-422 outlet

4.4 Power connection

There are, for redundancy purpose, two independent power inlets (Dsub, 9p, male, redundant solution) marked "POWER A" and "POWER B" with pinning as follows;

DC input voltage: #4

GND: #1

(Identical to solution for Flashlink frame FR-2RU-10-2)

4.5 CWDM filter



Figure 6

The CWDM filter contains 20pcs. LC connectors;

- 1pcs., "Common" port, marked "C"
- 1pcs. unused marked "x"
- 18pcs. ports in the range 1270 to 1610 nm marked "27" to "61"

5 Nevion SFPs

In the four SFP positions at the left (SDI, marked "1" to "8") only broadcast (non MSA) SFPs must be used.

In remaining 5 positions (ETH1000 and D-422-MG, marked "9" to "18") MSA SFPs must be used.

Concerning available SFPs for the different functions please contact Nevion's sales department.

6 Laser safety precautions

These are guidelines to limit hazards from laser exposure.

The lasers emit light at wave lengths between 1270 nm and 1610 nm. This means that the human eye cannot see the beam, and the blink reflex cannot protect the eye. (The human eye can see light between 400 nm to 700 nm).

A laser beam can be harmful to the human eye (depending on laser power and exposure time). Therefore:

Be careful when connecting / disconnecting fiber pigtails (ends).

Never look directly into the pigtail of the laser/fiber.

Never use microscopes, magnifying glasses or eye loupes to look into a fiber end.

Use laser safety goggles blocking light between 1270 nm and at 1610 nm

Instruments exist to verify light output power: Power meters, IR-cards etc.

Flashlink features:

The Flashlink Compact II is designed as Class 1 laser product according to EN 60 825-1:94/A11:96, and class IIIb according to CFR Ch1 (1997) Part 1040.10.

Maximum output power¹: < 17 mW

Operating wavelengths: > 1260 nm





¹ Max power is for safety analysis only and does not represent device performance.

General environmental requirements for Nevion equipment

1. The equipment will meet the guaranteed performance specification under the following environmental conditions:

Operating room temperature range: 0°C to 45°C

Operating relative humidity range: <90% (non-condensing)

2. The equipment will operate without damage under the following environmental conditions:

Temperature range: -10°C to 55°C

Relative humidity range: <95% (non-condensing)

Product Warranty

The warranty terms and conditions for the product(s) covered by this manual follow the General Sales Conditions by Nevion, which are available on the company web site:

www.nevion.com

Appendix A Materials declaration and recycling information

A.1 Materials declaration

For product sold into China after 1st March 2007, we comply with the "Administrative Measure on the Control of Pollution by Electronic Information Products". In the first stage of this legislation, content of six hazardous materials has to be declared. The table below shows the required information.

	Toxic or hazardous substances and elements					
組成名稱 Part Name	鉛 Lead (Pb)	汞 Mercury (Hg)	镉 Cadmium (Cd)	六价铬 Hexavalent Chromium (Cr(VI))	多溴联苯 Polybrominated biphenyls (PBB)	多溴二苯醚 Polybrominated diphenyl ethers (PBDE)
FC-3G-ETH-D422- SFP FC-3G-ETH-D422- CWDM-SFP	0	0	0	0	0	0
<power delivered="" if="" supply,="" unit="" with=""></power>	0	0	0	0	0	0

O: Indicates that this toxic or hazardous substance contained in all of the homogeneous materials for this part is below the limit requirement in SJ/T11363-2006.

This is indicated by the product marking:



A.2 Recycling information

Nevion provides assistance to customers and recyclers through our web site http://www.nevion.com/. Please contact Nevion's Customer Support for assistance with recycling if this site does not show the information you require.

Where it is not possible to return the product to Nevion or its agents for recycling, the following general information may be of assistance:

- Before attempting disassembly, ensure the product is completely disconnected from power and signal connections.
- All major parts are marked or labeled to show their material content.
- Depending on the date of manufacture, this product may contain lead in solder.
- Some circuit boards may contain battery-backed memory devices.

X: Indicates that this toxic or hazardous substance contained in at least one of the homogeneous materials used for this part is above the limit requirement in SJ/T11363-2006.